Bronze route inspired Nb₃Sn thin film coatings for SRF cavities

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Bronze route Nb₃Sn growth

- Mature technology in wire fabrication
- Solid state diffusion reaction between Nb and Cu-Sn solid solution
- Low temperature (~650 800 °C) Nb_3Sn phase purity



D. Dew-Hughes & T. S. Luhman Journal of Materials Science volume 13, pages1868– 1876(1978)





Why investigate bronze routes?

- Move reaction window from ~1100°C to ~700°C
 - Avoid the Nb₆Sn₅ and NbSn₂ phases by exploiting ternary Cu-Sn-Nb system
- Make the reaction compatible with cavity bodies made from copper; avoid bulk niobium (and)
 - Possible cost and formability advantages
 - High thermal conductivity of Cu
- Avoid Sn vapor, chlorides of Sn and Nb polishing chemistry (corrosive, toxicity).



J. P. Charlesworth et al J. Mat. Sci.5, 580 (1970)



Nb on 15wt.% Sn bronze

Bronze is cold-rolled and annealed at 525°C to homogenize, then mechanically polished



- This route is different than wires
- Bronze surface become Sn rich
- Very fast! 700 nm in only 22 minutes

- This route is like wires
- *In-situ* reaction without breaking vacuum
- 700 nm in 360 minutes





- Full reaction to Nb₃Sn phase at 715°C
 - Unreacted Nb at lower reaction temperature
- Strain in hot bronze samples ~ -1.2%
- Strain in post-reaction samples ~ -0.9%
- CTE mismatch (715 °C → 25°C) creates
 –0.7% strain (for 10%wt. Sn bronze)
- Hot bronze samples contain additional strain component
 - Strain determined from lattice parameter by peak fitting and Poisson's ratio



Hot bronze route gives Sn-rich Nb₃Sn ?!

- Hot bronze Sn ~26%
- Post-reaction ~ 24%
- Nb:Sn ratio from point scans in center of layer
- Tin-rich Nb₃Sn is not common for bronze reactions
- Relatively constant Sn content across thickness





Similar $T_{\rm c}$ in both cases!

- Strain affects T_c of Nb₃Sn
 - At zero strain & 25% Sn, T_c is ~18 K
- Similar T_c in both approaches, $T_c \sim 14-$ 16 K due to strain from CTE mismatch and intrinsic strain
- At lower temperature, unreacted Nb-> low Sn activity





Columnar grains in hot bronze samples

- Columnar grain growth in hot bronze sample -> zone 2 in Thornton SZD
- Smaller grains in post-reaction samples
- No cracks





Larger Nb₃Sn grain in hot bronze samples

- Larger Nb₃Sn grains in hot bronze case
- Surface avg. roughness is ~10 -15 nm in 100 um²
- Effects from underlying bronze substrate Sn contents seen in hot bronze samples
- No cracks





Discussion – Nb on hot bronze

- Tin-rich Nb₃Sn: 26% suggested by EDS
- But same T_c as for post-reaction, which EDS suggested was only

24% Sn

- Why?
 - Excess strain seen from XRD
 - Zone 2 in Thornton SZ diagram
 - Is the excess strain due to a new growth mode? We think so:

high mobility Volmer-Weber growth

- If so, this is new, and it is not available in solid-state reactions



Bronze on Nb

- Evaporation of bronze reduces steps involved
- Sn gradient in the Nb₃Sn layer, 25% to 18%
 - Susceptible to oxidation 2 µr



2 μ m 40% Sn bronze layer on Nb + 6 hours at 700 °C







How to use Cu substrate and scaling to cavities

- $2 5 \mu m$ high Sn bronze layer is enough to produce ~1-2 μm Nb₃Sn layer
- Diffusion barriers -> stop Sn diffusion into Cu
- Bronze/Ta/Cu can be used in hot-bronze or post-reaction method
- Nb₃Sn grain size can be controlled with Sn content in bronze layer
- Nb/Cu can be used with bronze evaporation + heat treatment+etch approach
- Process can be scaled to cavity coating easily





Summary

- Deposition of Nb onto hot bronze seems to be very promising
 - Tin-rich coating
 - Rapid growth of layer
 - Zone 2 grain structure
- A wide range of substrate configurations is possible
 - Diffusion barriers and CTE adjustments
 - Compatibility with external copper bulk
- Schemes for scaling to cavities are in progress



- Alexander Wozny and Jonathan Wozny for their support with bronze substrate polishing.
- This work at ASC, NHMFL-FSU was funded by U.S. Department of Energy, Office of Science, Office of High Energy Physics under Award No. DE-SC 0018379.
- A portion of this work was performed at the National High Magnetic Field Laboratory, which is supported by National Science Foundation Cooperative Agreement No. DMR-1644779 and the State of Florida.



Backup Slides



Typical stress development in high-mobility VM growth



Figure 9. High-mobility Volmer–Weber growth: film forces per unit width against mean thickness (left-hand side) and time (right-hand side) of Ag, Cu, Au (from [16]) and Al films (from [9] by courtesy of R Abermann) UHV deposited at room temperature onto MgF_2 coated glass substrates.

Koch R 1994 J. Phys.: Condens. Matter 6 9519



$T_{\rm c}$ vs Sn content



MATIONAL AGLAB I CONCERNING A Godeke 2006 Supercond. Sci. Technol. 19 R68

CTE mismatch





SZD





A. Anders Thin Solid Films 518 (2010) 4087-4090

Proposed deposition chamber



